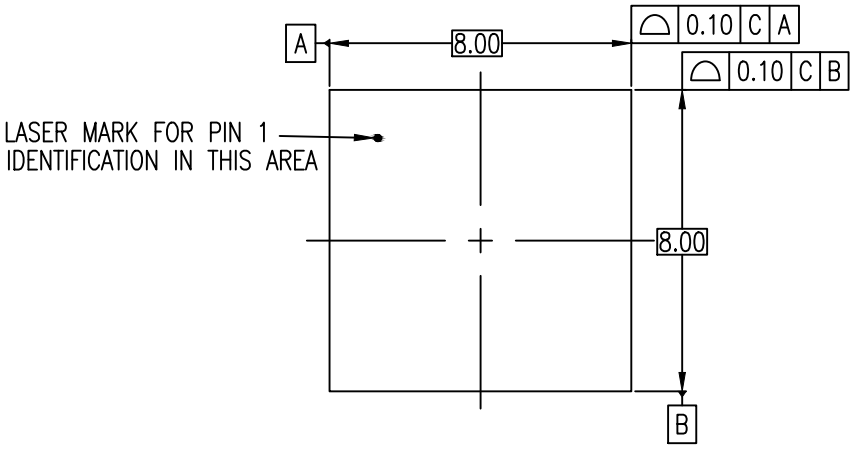
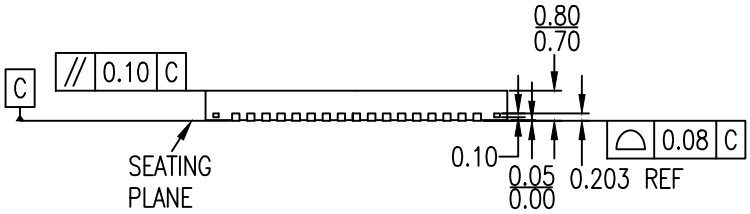
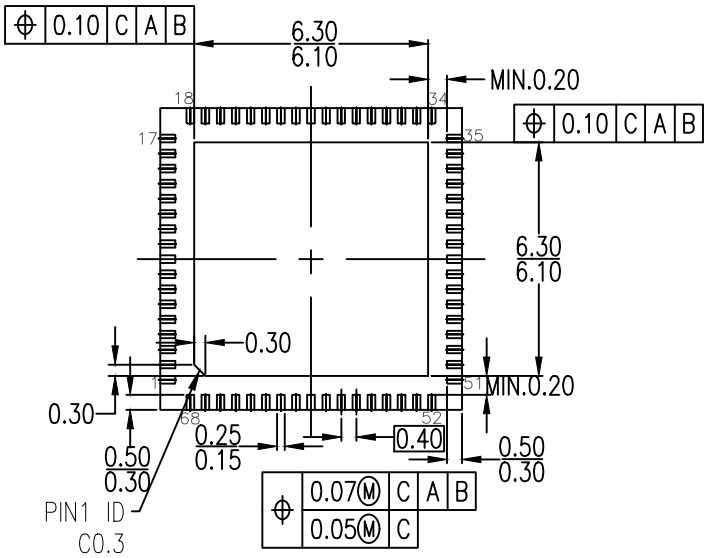


TOP VIEW



SIDE VIEW



BOTTOM VIEW

NOTES :
1.ALL DIMENSIONS ARE IN MILLIMETERS.
2.DIMENSIONING & TOLERANCES CONFORM TO ASME Y14.5M. -1994.
3.THE PIN #1 IDENTIFIER MUST BE PLACED ON THE TOP SURFACE OF THE
4.PACKAGE WARPAGE MAX 0.08 mm.

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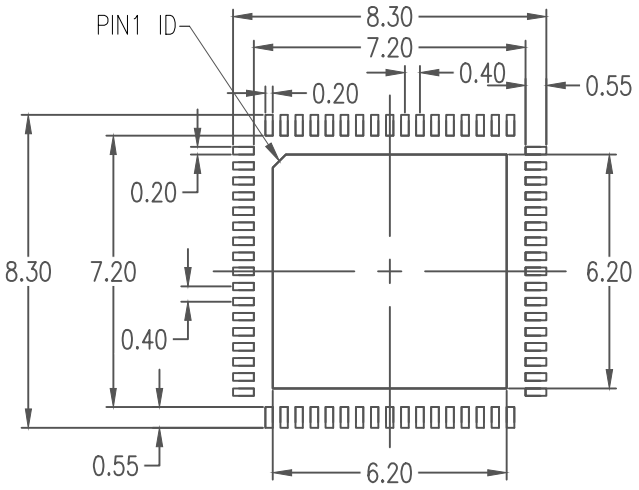

RECOMMENDED LAND PATTERN

NOTES:
1. ALL DIMENSIONS ARE IN MM. ANGLES IN DEGREES.
2. TOP DOWN VIEW. AS VIEWED ON PCB.
3. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

Package Revision History		
Date Created	Rev No.	Description
Feb 12, 2018	Rev 02	New Format, Change QFN to VFQFPN
April 12, 2016	Rev 01	Update Land Pattern

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